

# STU13005

# High voltage fast-switching NPN power transistor

#### Datasheet - obsolete product

### Features

- Low spread of dynamic parameters
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

### **Applications**

- Electronic ballast for fluorescent lighting
- Switch mode power supplies

### Description

This device is manufactured using high voltage multi epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining a wide RBSOA.

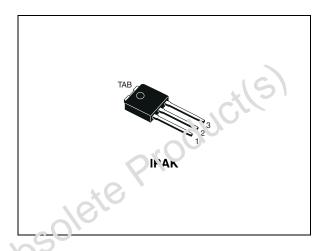
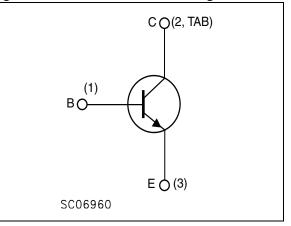


Figure 1. Internal schematic diagram



<b>T</b> . I. I. A	<b>D</b>	
Table 1.	Device	summary

Order codes	Marking	Package	Packaging
STU13005	U13005	IPAK	Tube

#### **Electrical ratings** 1

Symbol	Parameter	Value	Unit	
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	700	V	
V <sub>CEO</sub>	Collector-emitter voltage (I <sub>B</sub> = 0)	400	V	
$V_{\text{EBO}}$	Emitter-base voltage ( $I_C = 0$ )	9	V	
۱ <sub>C</sub>	Collector current	4	А	
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5 ms)	8	A	
Ι <sub>Β</sub>	Base current	2	А	
I <sub>BM</sub>	Base peak current (t <sub>P</sub> < 5 ms)	4	А	
P <sub>TOT</sub>	Total dissipation at $T_c \le 25 \text{ °C}$	30	W	
T <sub>STG</sub>	Storage temperature	- 65 to 150	°C	
TJ	Max. operating junction temperature	150	°C	
Table 3. Thermal data				
Symbol	Paramotor	Value	Unit	

	Symbol Parameter		Value	Unit	
	R <sub>thj-case</sub>	Thermal resi, tanc ) junction-case max	4.2	°C/W	
	R <sub>thj-amb</sub>	Thermal resistance junction-amb max	100	°C/W	
obsole	tePr				



## 2 Electrical characteristics

 $T_{case} = 25 \ ^{\circ}C$  unless otherwise specified.

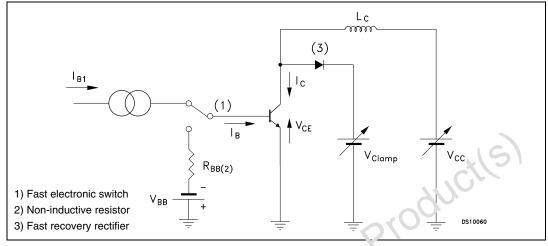
Table 4.Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current $(V_{BE} = 0)$	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V T <sub>C</sub> =125 °C			1 5	mA mA
I <sub>EBO</sub>	Emitter cut-off current $(I_{\rm C} = 0)$	V <sub>EB</sub> = 9 V				mA
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage (I <sub>B</sub> = 0)	I <sub>C</sub> =10 mA	400			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage		0)		0.5 0.6 1	V V V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	$I_{C} = 1 A$ $I_{D} = 0.2 A$ $I_{C} = 2 A$ $G_{D} = 0.5 A$			1.2 1.6	V V
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$I_{C} = 1 A$ $V_{CE} = 5 V$ $V_{CE} = 5 V$ $V_{CE} = 5 V$	16 8		32 40	
	Resistive load	$V_{\rm CC} = 2  {\rm A}$ $V_{\rm CC} = 125  {\rm A}$				
t <sub>s</sub> t <sub>f</sub>	Storage time Fall time	I <sub>B1</sub> = - I <sub>B2</sub> =0.4 Α t <sub>p</sub> = 30 μs		2.2 0.2		μs μs

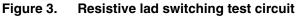
1. Pulse test: pulse duration :: 500  $\mu s$ , duty cycle  $\leq 2$  %.

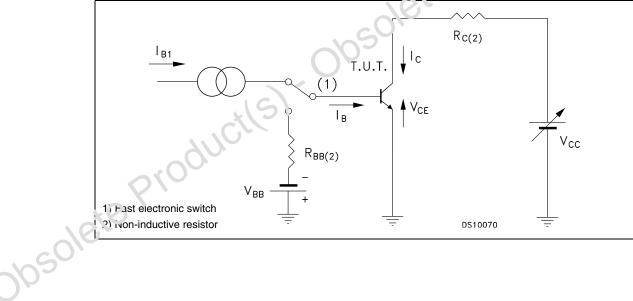


### 2.1 Test circuits



### Figure 2. Inductive load switching test circuit





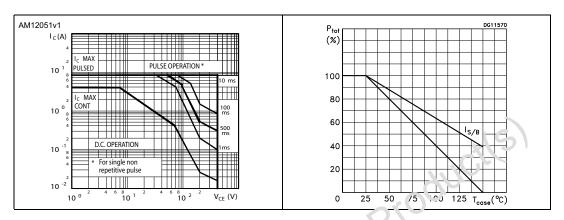


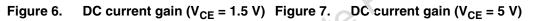
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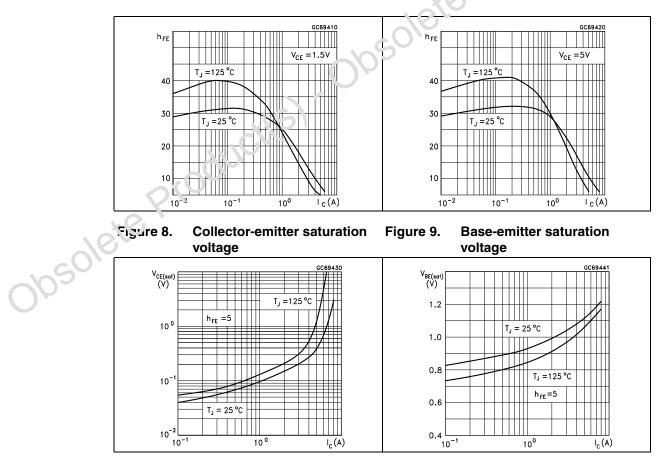
### 2.2 Electrical characteristics (curves)



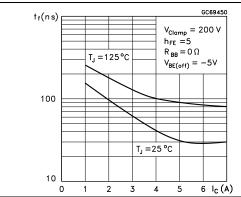




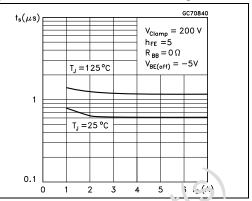




#### Figure 10. Inductive load fall time



#### Figure 11. Inductive load storage time







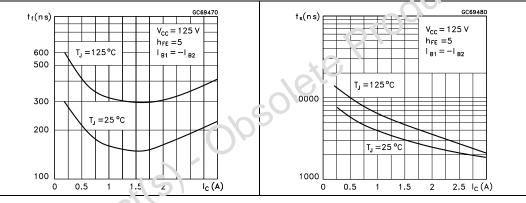
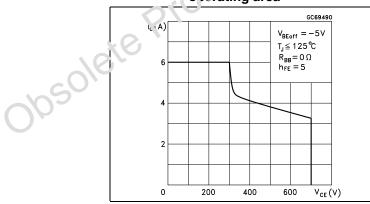


Figure 14. Reverse biased safe overating area





### 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

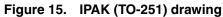


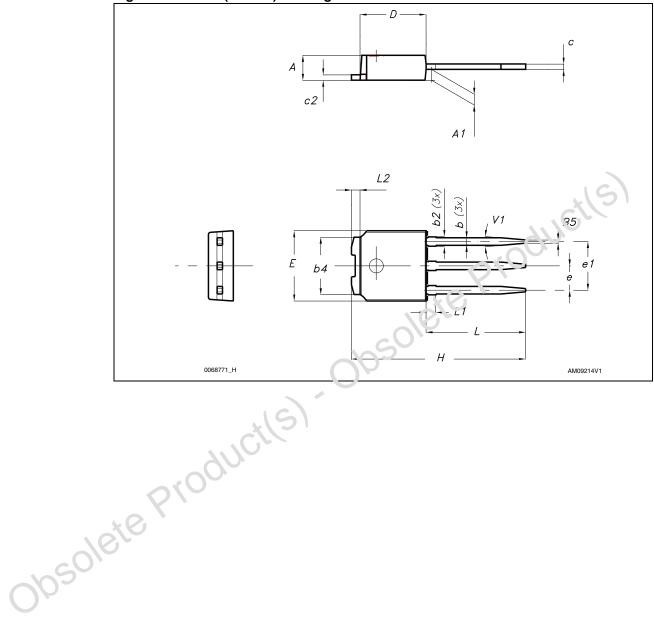
obsolete Product(s). Obsolete Product(s)

DIM.			
	mm.		
Diwi.	min.	typ	max.
А	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.3	
с	0.45		0.50
c2	0.48		0.60
D	6.00		6.20
E	6.40	2	6.60
е		2.28	
e1	4.40	100	4.60
Н		6.10	
L	9.00	<u> </u>	9.40
L1	0.80		1.20
L2	.16)	0.80	1.00
V1		10 <sup>o</sup>	

Table 5. IPAK (TO-251) mechanical data









### 4 Revision history

### Table 6.Document revision history

	Date	Revision	Changes
	13-Dec-2011	1	First release
	13-Mar-2012	2	The part number STI13005-H has been moved to a separate datasheet
obsole	tepro	ductl	obsolete Product(s)





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